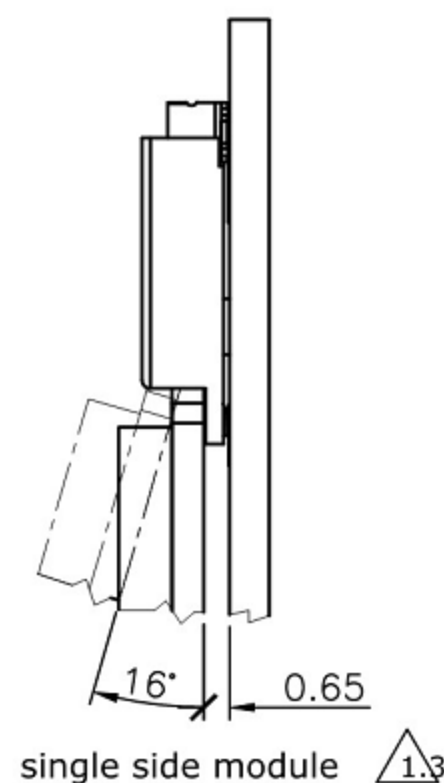
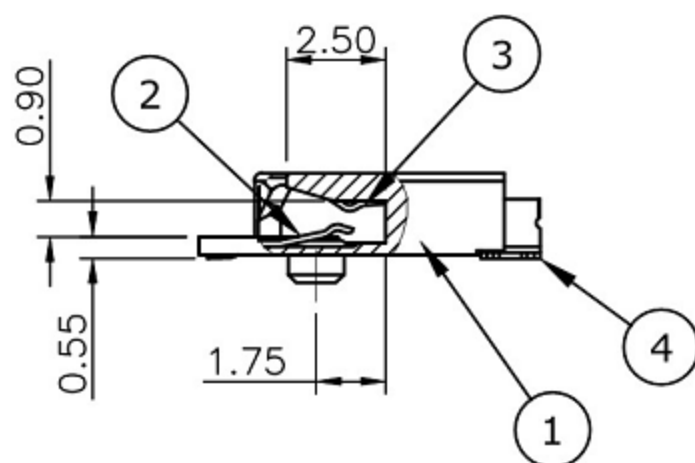
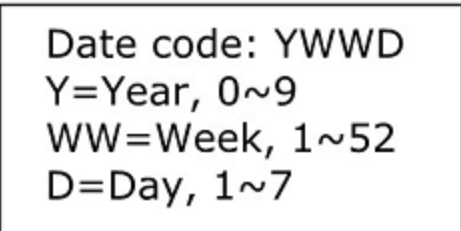


ROHS



Recommended Layout (Top View)
General Tolerance: $\pm 0.05\text{mm}$

REV.	DESCRIPTION	DRAWN	DATE
1.1	Add flatness tolerance	FROS	2019/08/07
1.2	Corrected temperature to 85°C	FROS	2019/08/15
1.3	add note	FROS	2019/08/29

SPECIFICATION:

1. ELECTRICAL

- 1.1 Current Rating: 0.5A per pin
- 1.2 Voltage Rating: 50VAC
- 1.3 Contact Resistance: 50mΩ
- 1.4 Insulation Resistance: 500MΩ
- 1.5 Dielectric Withstanding Voltage: 300VAC

2. MECHANICAL

- 2.1 Durability: 60 Cycle
- 2.2 Mating Force: 20N max.
- 2.3 Un-mating Force: 25N max.

1.2 3. ENVIRONMENTAL

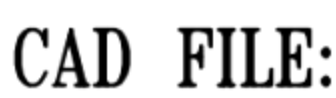
- 3.1 Operating temperature range: -40°C~+85°C
3.2 Storage temperature range: -40°C~+85°C

4. SOLDER ABILITY

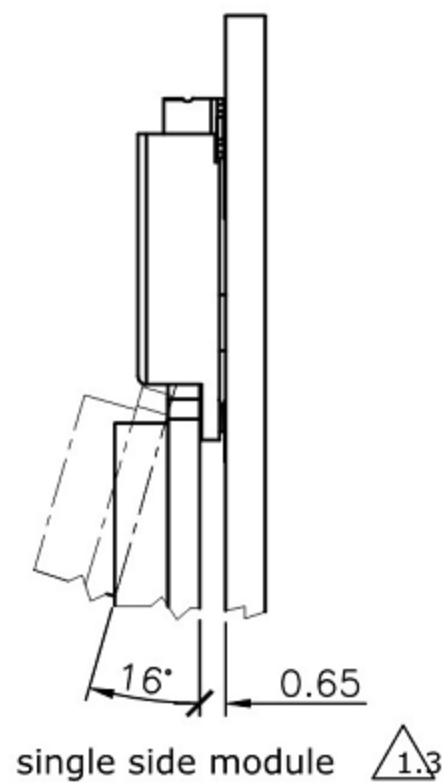
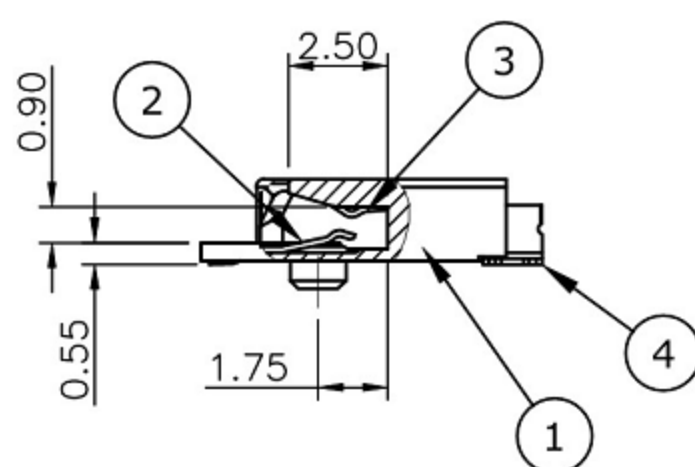
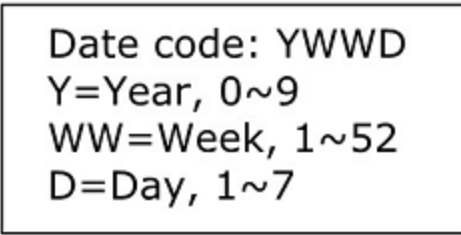
- 4.1 Recommended IR Reflow(Wave Soldering)
Temperature: 260°C

4	HOLD DOWN	BRASS, C2680R-H, 100u" Matte Tin plated, under-plated Nickel 50u"
3	LOWER CONTACT	PHOSPHOR BRONZE, C5210R-EH Contact area: Gold flash, Solder area: Gold flash, all under-plated Nickel 50u"
2	UPPER CONTACT	
1	INSULATOR	LCP, UL94V-0, BLACK
NO.	PART NAME	DESCRIPTION

8					TOLERANCE UNLESS SPECIFIED						
7											
6					WITHIN 1.5mm : ±0.1mm	A	2012-9-25	初 版		ZENQ. CHEN	
5					OVER 1.5mm : ±0.2mm	ISSUE	DATE	DESCRIPTIONS OF REVISION		APPD.	
4	CONTACT	SUS	1	Ag CLAD	TITLE : PCB卡插座			UNIT : mm	DRWG NO.: XB-123A-21X00		
3	CASE	PPA/BRASS SRTIP	1	BLACK/Ag PLATED	MODEL: PCB Card Socket			SCALE: 5:1	DWN.	JUN. YANG	2012-9-25
2	COVER	STEEL STRIP	1	Ni PLATED	 东莞市溪榜电子有限公司 DONG GUAN XI BANG ELECTRONI CS CO., LTD.			CHK'D	DONG. PANG	2012-9-25	
1	KNOB	PPA	1	BLACK				APPD.	ZENQ. CHEN	2012-9-25	
NO.	PARTS	MATERIALS	Q'TY	FINISH							



ROHS



Recommended Layout (Top View)
General Tolerance: $\pm 0.05\text{mm}$

REV.	DESCRIPTION	DRAWN	DATE
1.1	Add flatness tolerance	FROS	2019/08/07
1.2	Corrected temperature to 85°C	FROS	2019/08/15
1.3	add note	FROS	2019/08/29

SPECIFICATION:

1. ELECTRICAL

- 1.1 Current Rating: 0.5A per pin
- 1.2 Voltage Rating: 50VAC
- 1.3 Contact Resistance: 50mΩ
- 1.4 Insulation Resistance: 500MΩ
- 1.5 Dielectric Withstanding Voltage: 300VAC

2. MECHANICAL

- 2.1 Durability: 60 Cycle
- 2.2 Mating Force: 20N max.
- 2.3 Un-mating Force: 25N max.

1.2 3. ENVIRONMENTAL

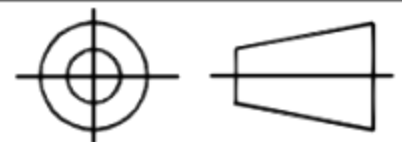
- 3.1 Operating temperature range: -40°C~+85°C
3.2 Storage temperature range: -40°C~+85°C

4. SOLDER ABILITY

- 4.1 Recommended IR Reflow(Wave Soldering)
Temperature: 260°C

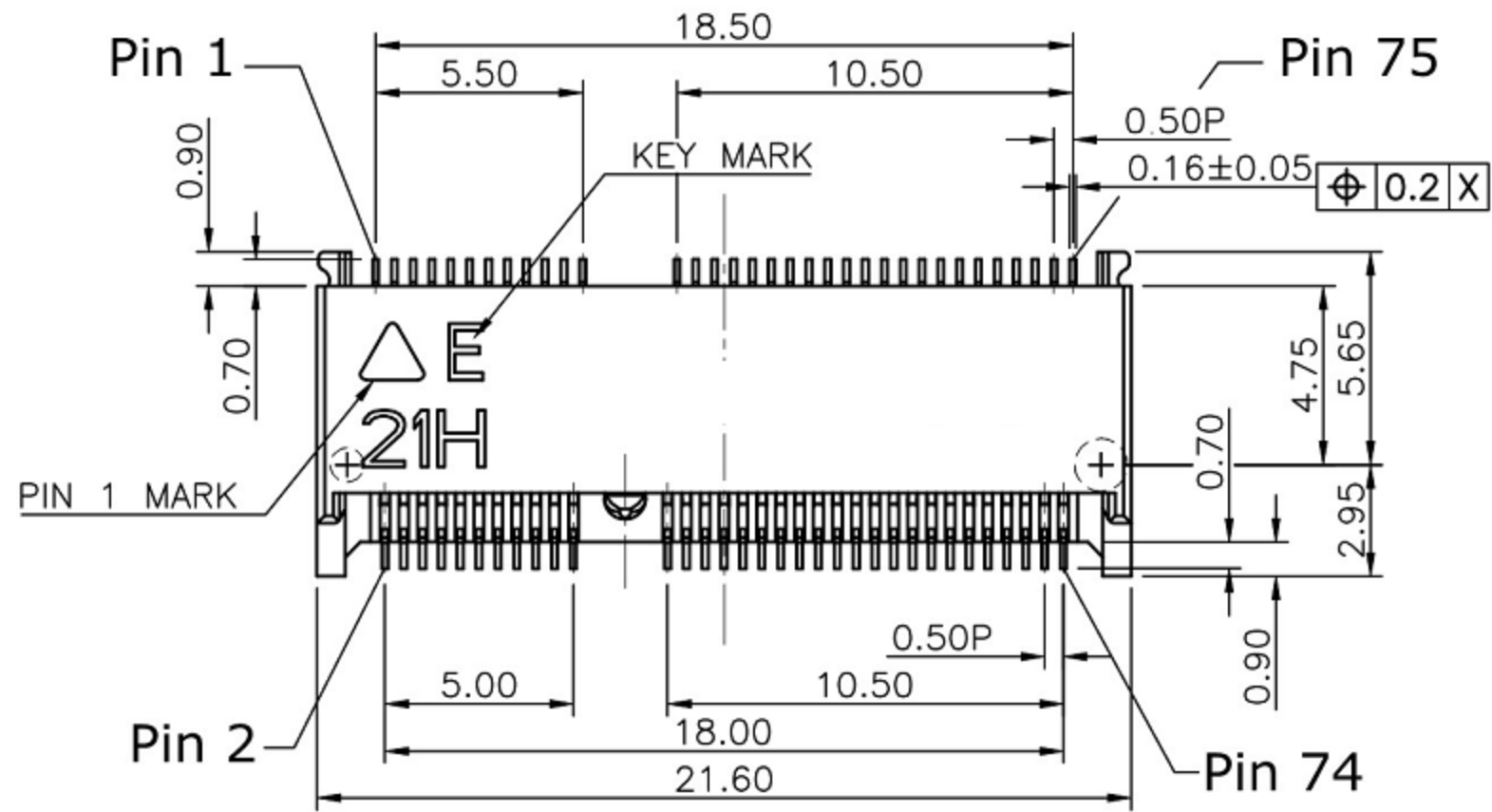
4	HOLD DOWN	BRASS, C2680R-H, 100u" Matte Tin plated, under-plated Nickel 50u"
3	LOWER CONTACT	PHOSPHOR BRONZE, C5210R-EH
2	UPPER CONTACT	Contact area: Gold flash, Solder area: Gold flash, all under-plated Nickel 50u"
1	INSULATOR	LCP, UL94V-0, BLACK
NO.	PART NAME	DESCRIPTION

8					TOLERANCE UNLESS SPECIFIED						
7											
6					WITHIN 1.5mm : ±0.1mm	A	2012-9-25	初 版		ZENQ. CHEN	
5					OVER 1.5mm : ±0.2mm	ISSUE	DATE	DESCRIPTIONS OF REVISION		APPD.	
4	CONTACT	SUS	1	Ag CLAD	TITLE : PCB卡插座			UNIT : mm	DRWG NO.: XB-123A-21X00		
3	CASE	PPA/BRASS SRTIP	1	BLACK/Ag PLATED	MODEL: PCB Card Socket			SCALE: 5:1	DWN.	JUN. YANG	2012-9-25
2	COVER	STEEL STRIP	1	Ni PLATED				CHK'D	DONG. PANG	2012-9-25	
1	KNOB	PPA	1	BLACK	 东莞市溪榜电子有限公司 DONG GUAN XI BANG ELECTRONI CS CO., LTD.			APPD.	ZENQ. CHEN	2012-9-25	
NO.	PARTS	MATERIALS	Q'TY	FINISH							

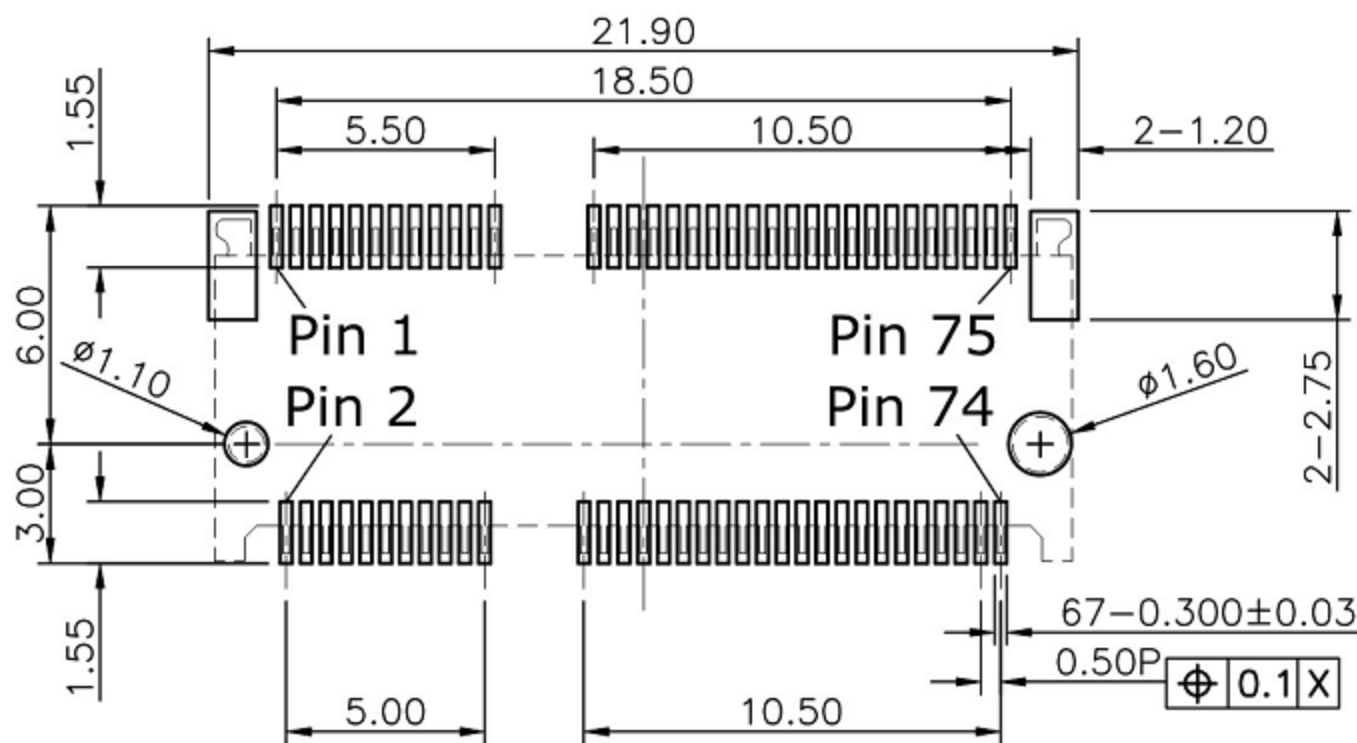
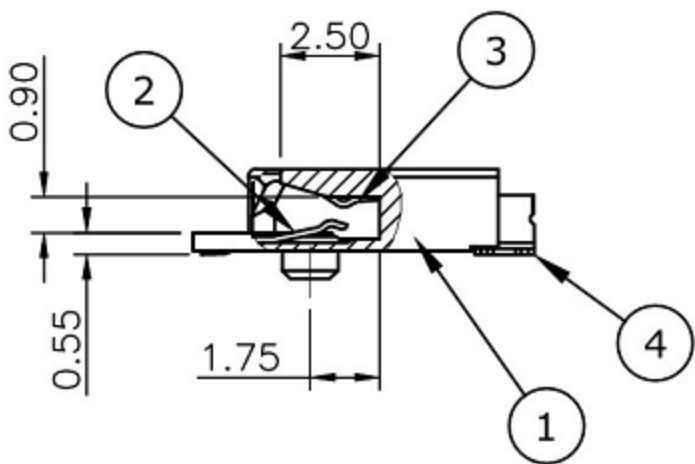
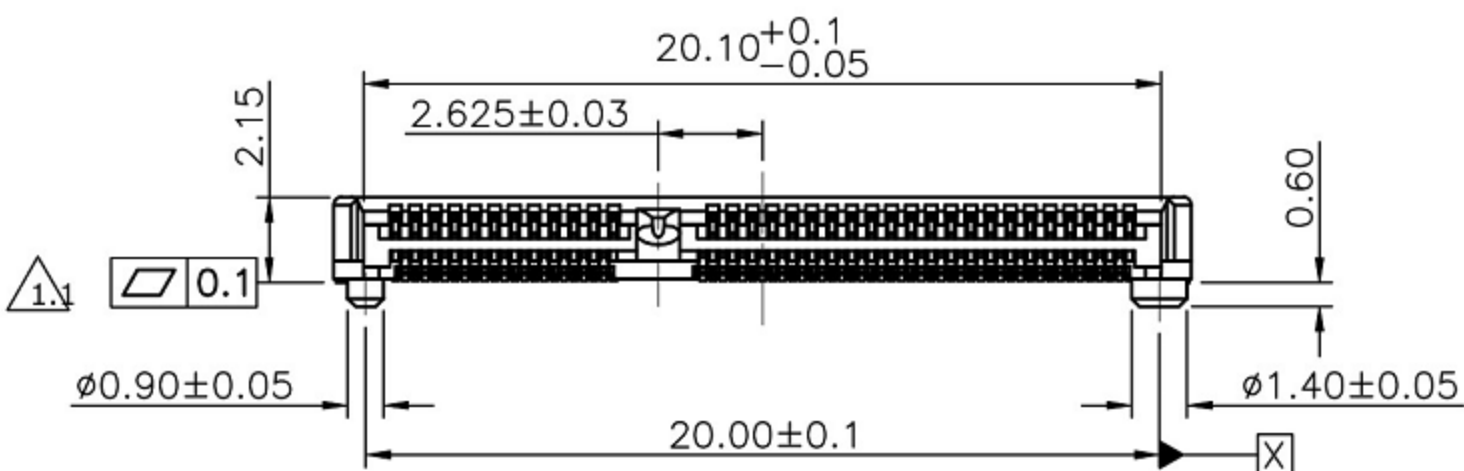


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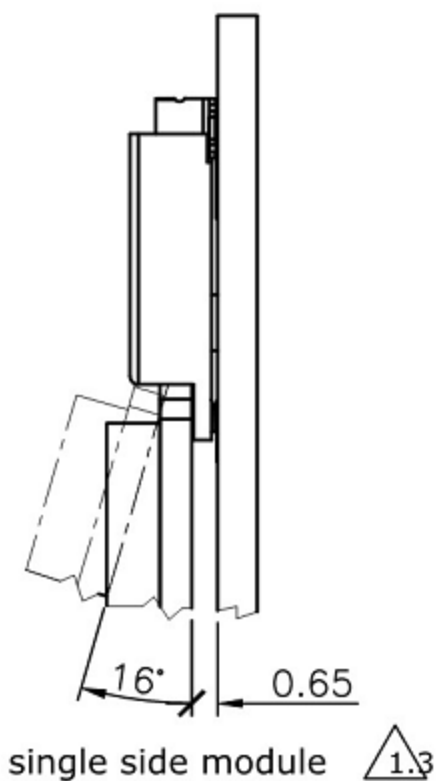
ROHS



Date code: YWWD
Y=Year, 0~9
WW=Week, 1~52
D=Day, 1~7



Recommended Layout (Top View)
General Tolerance: ±0.05mm



REV.	DESCRIPTION	DRAWN	DATE
1.1	Add flatness tolerance	FROS	2019/08/07
1.2	Corrected temperature to 85°C	FROS	2019/08/15
1.3	add note	FROS	2019/08/29

SPECIFICATION:

- ELECTRICAL
 - Current Rating: 0.5A per pin
 - Voltage Rating: 50VAC
 - Contact Resistance: 50mΩ
 - Insulation Resistance: 500MΩ
 - Dielectric Withstanding Voltage: 300VAC

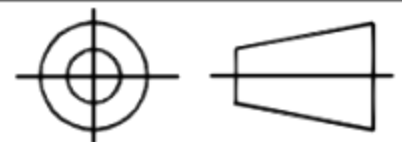
- MECHANICAL
 - Durability: 60 Cycle
 - Mating Force: 20N max.
 - Un-mating Force: 25N max.

- ENVIRONMENTAL
 - Operating temperature range: -40°C~+85°C
 - Storage temperature range: -40°C~+85°C

- SOLDER ABILITY
 - Recommended IR Reflow(Wave Soldering)
Temperature: 260°C

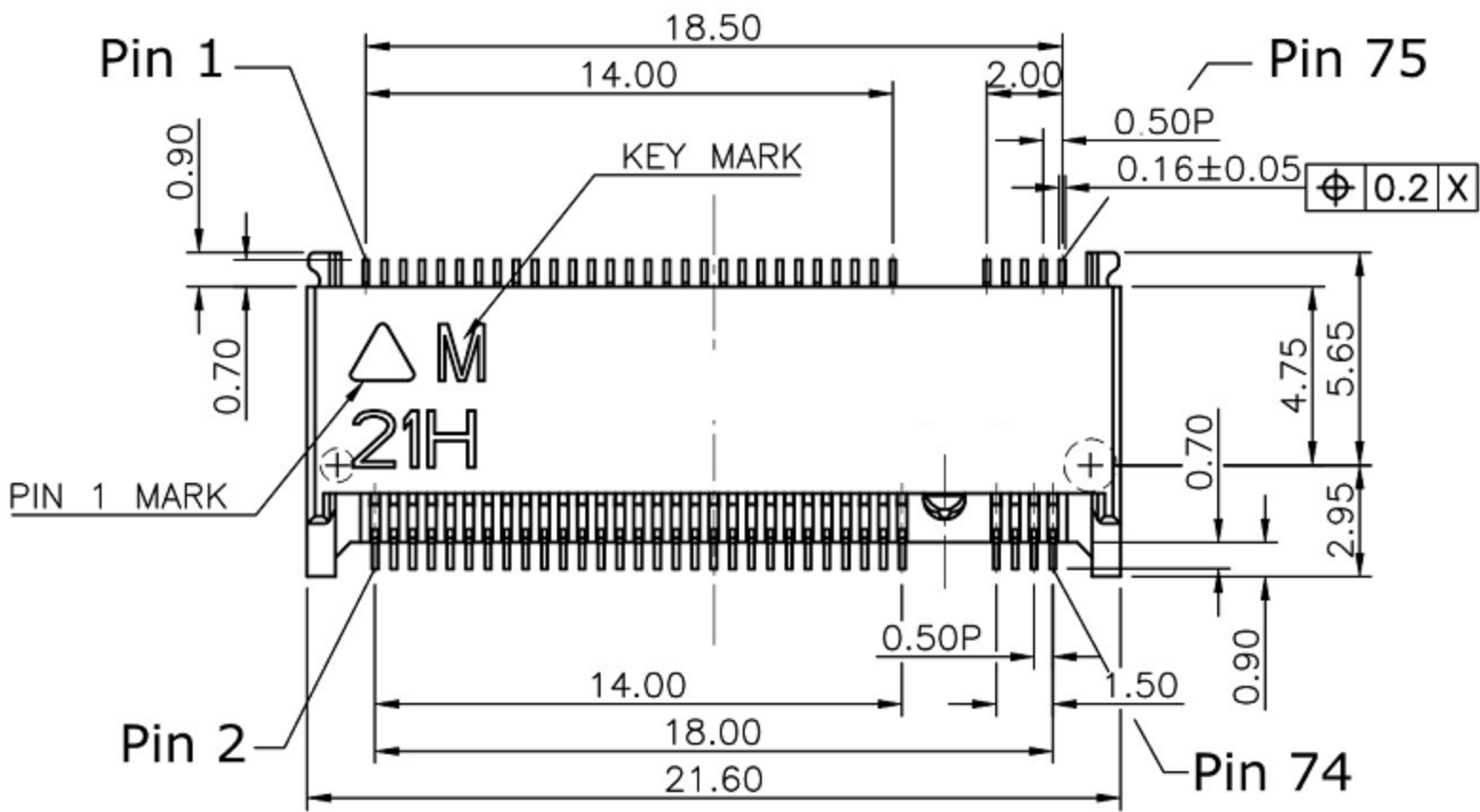
4	HOLD DOWN	BRASS, C2680R-H, 100u" Matte Tin plated, under-plated Nickel 50u"
3	LOWER CONTACT	PHOSPHOR BRONZE, C5210R-EH
2	UPPER CONTACT	Contact area: Gold flash, Solder area: Gold flash, all under-plated Nickel 50u"
1	INSULATOR	LCP, UL94V-0, BLACK
NO.	PART NAME	DESCRIPTION

8					TOLERANCE				
7					UNLESS SPECIFIED				
6					WITHIN 1.5mm : ±0.1mm	A	2012-9-25	初 版	ZENQ. CHEN
5					OVER 1.5mm : ±0.2mm	ISSUE	DATE	DESCRIPTIONS OF REVISION	APPD.
4	CONTACT	SUS	1	Ag CLAD	TITLE : PCB卡插座			UNIT : mm	DRWG NO.: XB-123A-21X00
3	CASE	PPA/BRASS SRTIP	1	BLACK/Ag PLATED	MODEL: PCB Card Socket			SCALE: 5:1	DWN. JUN. YANG 2012-9-25
2	COVER	STEEL STRIP	1	Ni PLATED	 东莞市溪榜电子有限公司 DONG GUAN XI BANG ELECTRONICS CO., LTD.			CHK'D	DONG. PANG 2012-9-25
1	KNOB	PPA	1	BLACK				APPD.	ZENQ. CHEN 2012-9-25
NO.	PARTS	MATERIALS	Q'TY	FINISH					

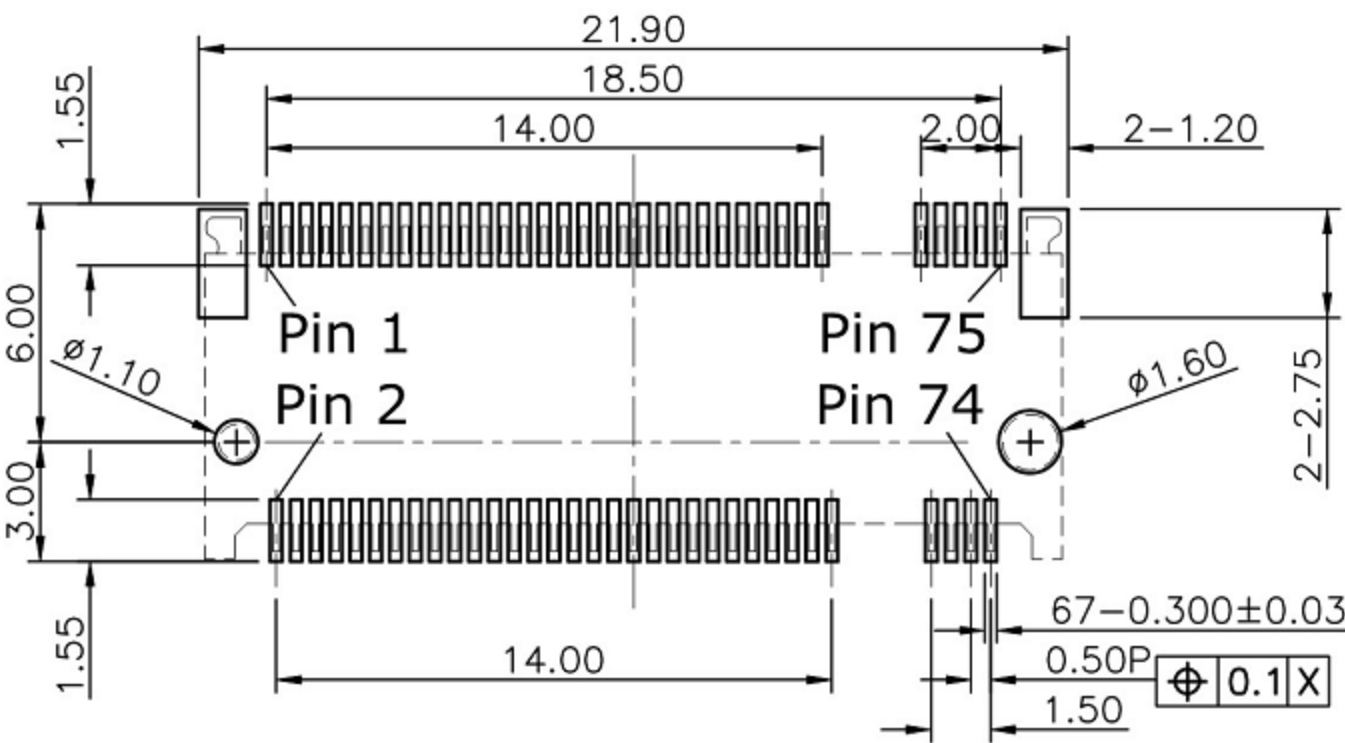
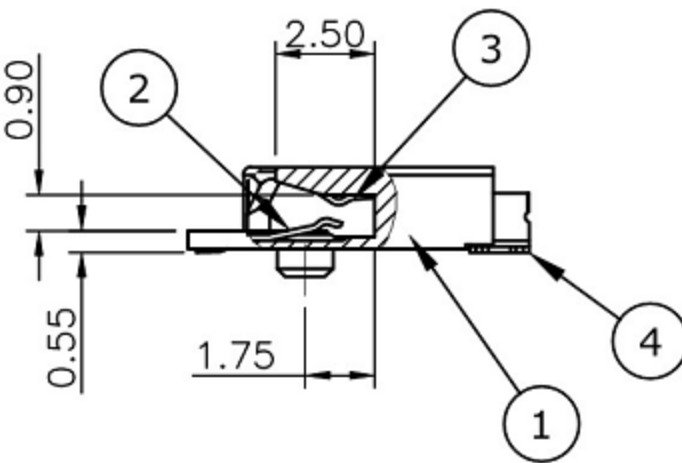
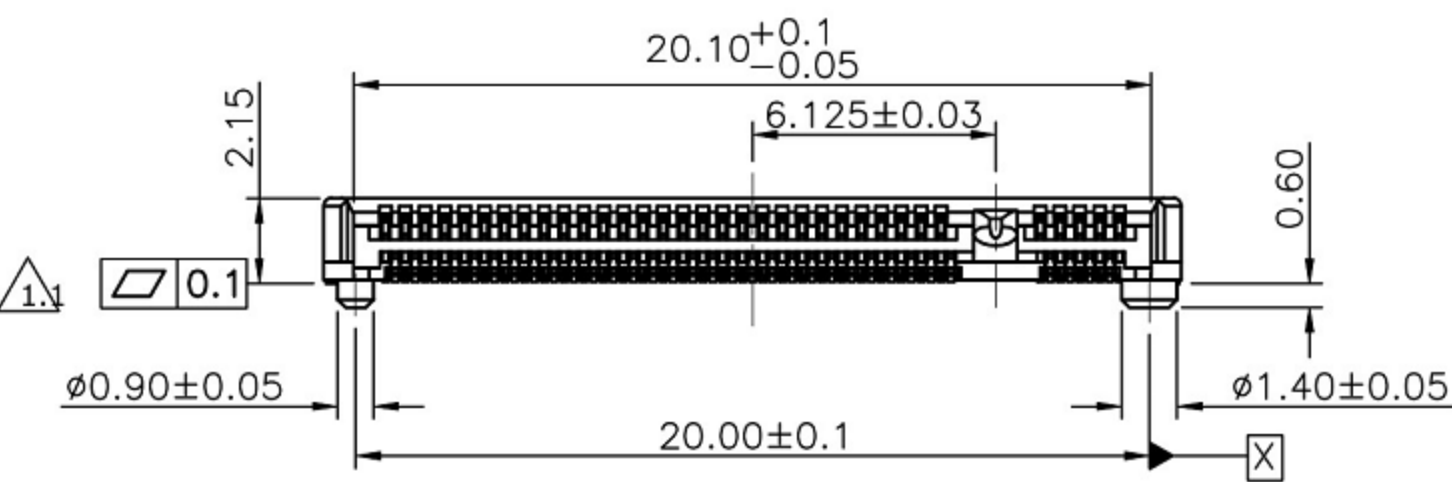


CAD FILE:

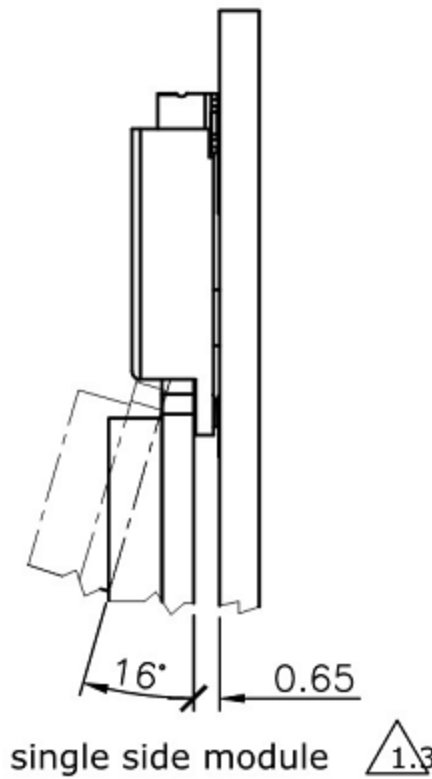
ROHS



Date code: YWWD
Y=Year, 0~9
WW=Week, 1~52
D=Day, 1~7



Recommended Layout (Top View)
General Tolerance: ±0.05mm



REV.	DESCRIPTION	DRAWN	DATE
1.1	Add flatness tolerance	FROS	2019/08/07
1.2	Corrected temperature to 85°C	FROS	2019/08/15
1.3	add note	FROS	2019/08/29

SPECIFICATION:

- ELECTRICAL
 - Current Rating: 0.5A per pin
 - Voltage Rating: 50VAC
 - Contact Resistance: 50mΩ
 - Insulation Resistance: 500MΩ
 - Dielectric Withstanding Voltage: 300VAC

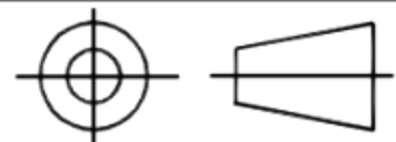
- MECHANICAL
 - Durability: 60 Cycle
 - Mating Force: 20N max.
 - Un-mating Force: 25N max.

- ENVIRONMENTAL
 - Operating temperature range: -40°C~+85°C
 - Storage temperature range: -40°C~+85°C

- SOLDER ABILITY
 - Recommended IR Reflow(Wave Soldering)
Temperature: 260°C

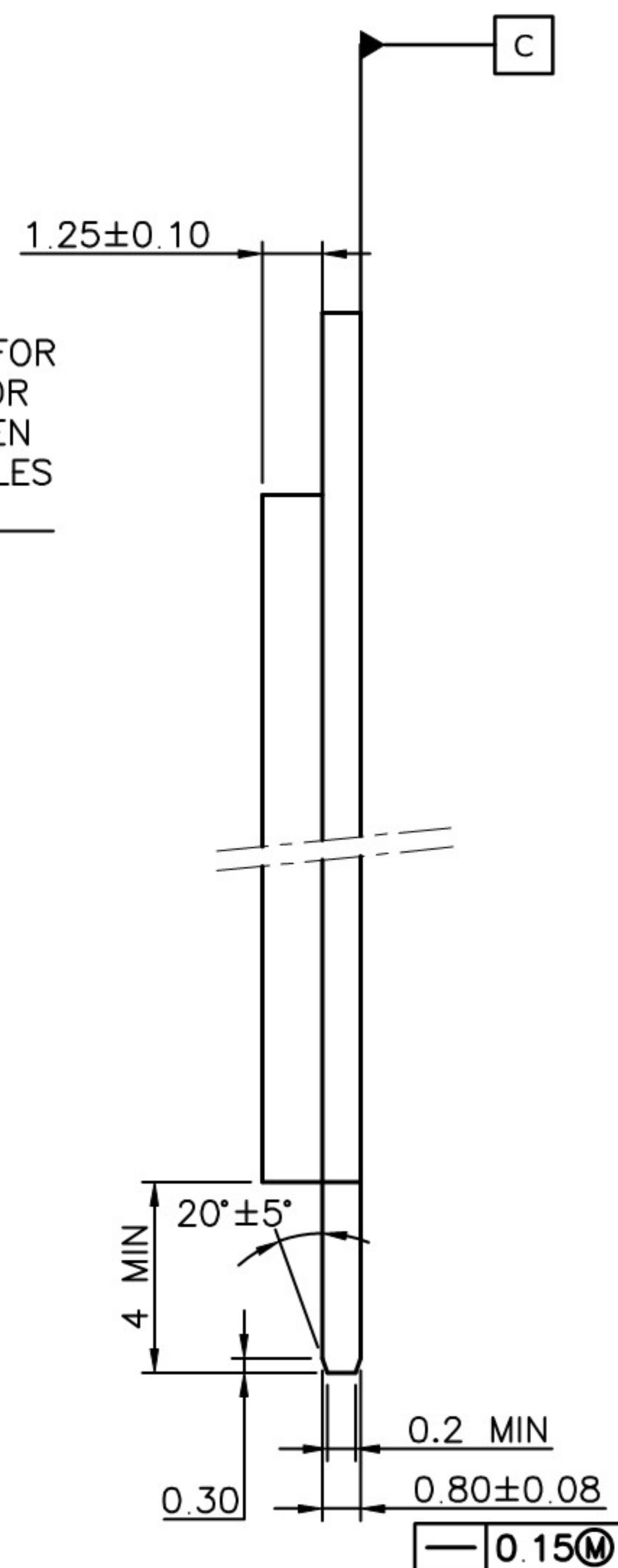
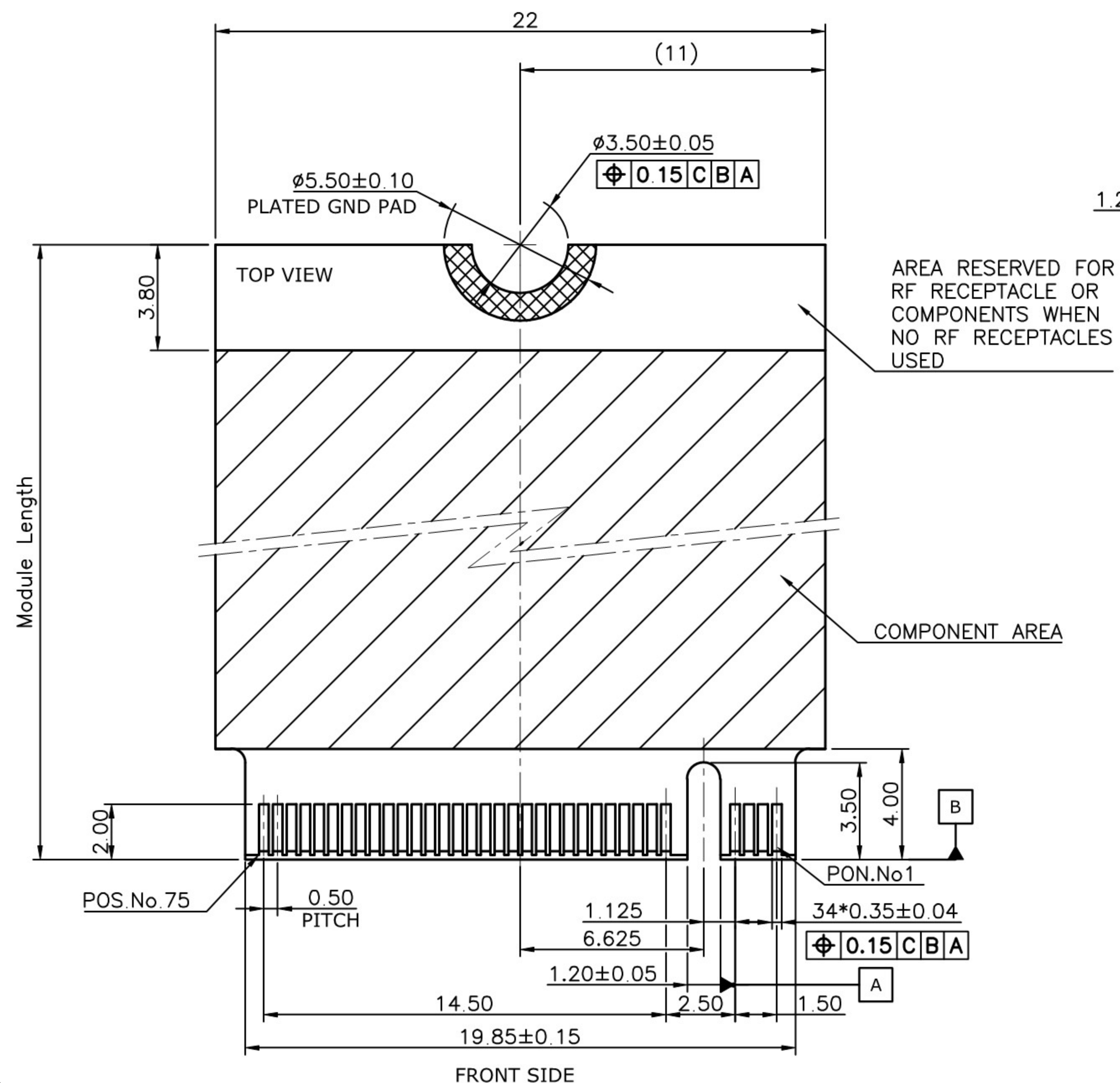
4	HOLD DOWN	BRASS, C2680R-H, 100u" Matte Tin plated, under-plated Nickel 50u"
3	LOWER CONTACT	PHOSPHOR BRONZE, C5210R-EH
2	UPPER CONTACT	Contact area: Gold flash, Solder area: Gold flash, all under-plated Nickel 50u"
1	INSULATOR	LCP, UL94V-0, BLACK
NO.	PART NAME	DESCRIPTION

8					TOLERANCE				
7					UNLESS SPECIFIED				
6					WITHIN 1.5mm : ±0.1mm	A	2012-9-25	初 版	ZENQ. CHEN
5					OVER 1.5mm : ±0.2mm	ISSUE	DATE	DESCRIPTIONS OF REVISION	APPD.
4	CONTACT	SUS	1	Ag CLAD	TITLE : PCB卡插座			UNIT : mm	DRWG NO.: XB-123A-21X00
3	CASE	PPA/BRASS SRTIP	1	BLACK/Ag PLATED	MODEL: PCB Card Socket			SCALE: 5:1	DWN. JUN. YANG 2012-9-25
2	COVER	STEEL STRIP	1	Ni PLATED	 东莞市溪榜电子有限公司 DONG GUAN XI BANG ELECTRONI CS CO., LTD.			CHK'D DONG. PANG 2012-9-25	
1	KNOB	PPA	1	BLACK				APPD. ZENQ. CHEN 2012-9-25	
NO.	PARTS	MATERIALS	Q'TY	FINISH					

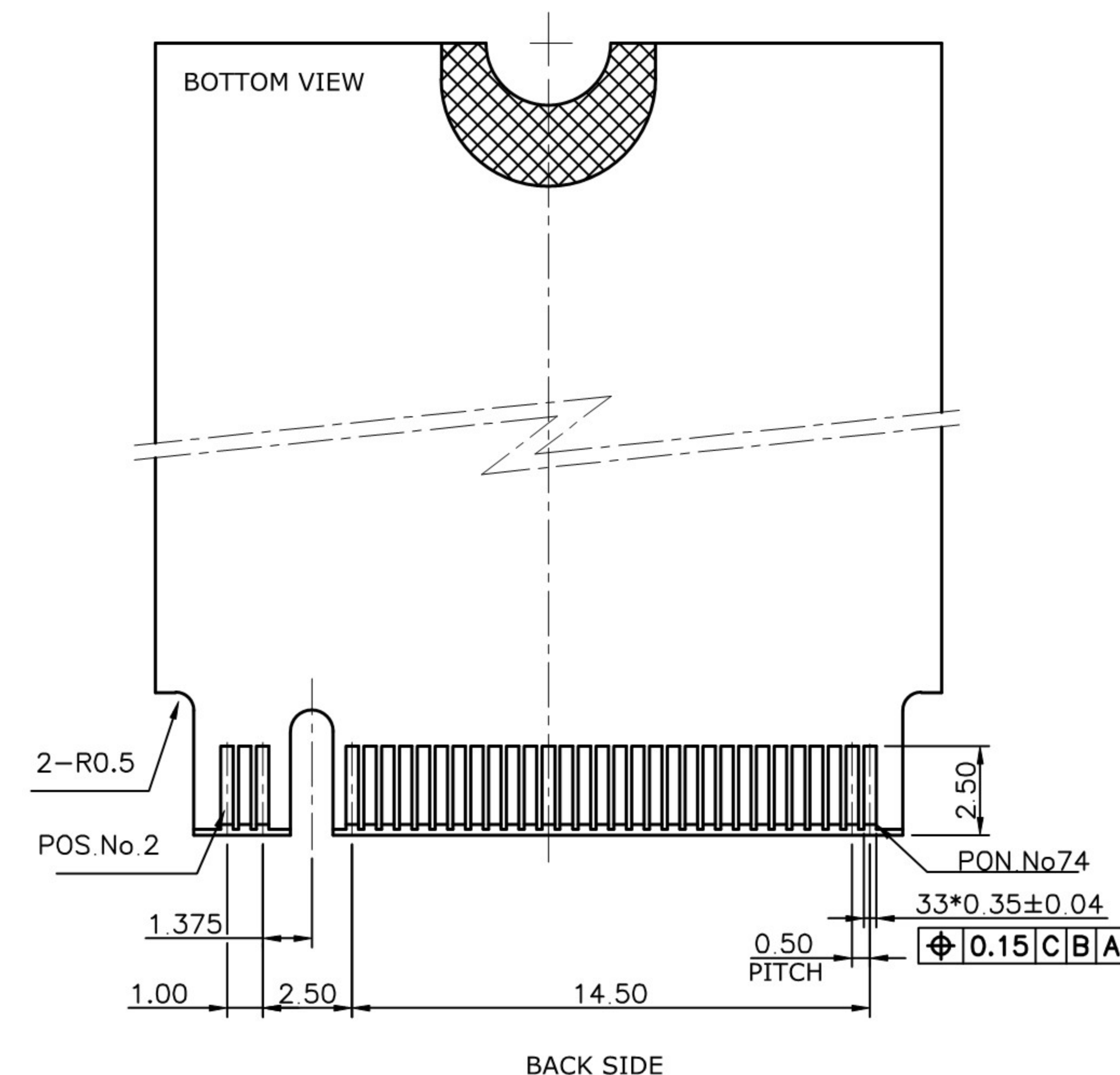


CAD FILE:

ROHS



REV.	DESCRIPTION	DRAWN	DATE
1	INITIAL RELEASE	FROS	2019/01/09
1.1	Corrected	FROS	2019/09/11



Module Length (mm)
42
60
80
110

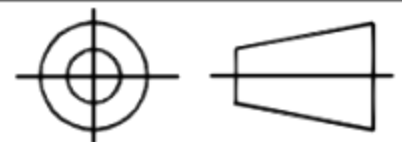
KEY ID "A"

RECOMMENDED MODULE LAYOUT

3	CASE	PPA/BRASS SRTIP	1	BLACK/Ag PLATED
2	COVER	STEEL STRIP	1	Ni PLATED
1	KNOB	PPA	1	BLACK
NO.	PARTS	MATERIALS	Q'TY	FINISH

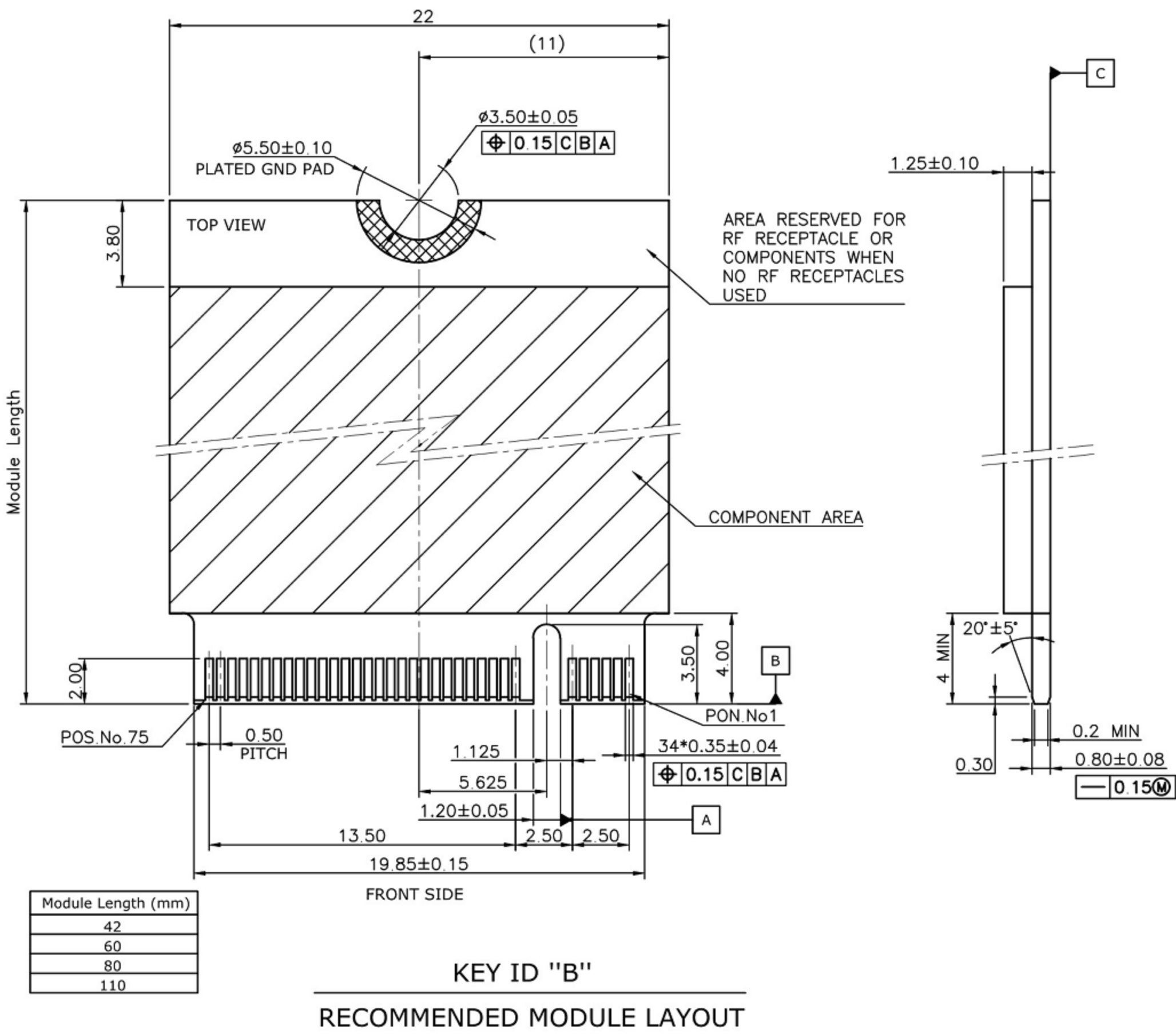
MODEL: PCB Card Socket		SCALE: 5:1	DWN.	JUN. YANG	2012-9-25
卡插座		UNIT : mm	DRWG NO.: XB-123A-21X00		
东莞市溪榜电子有限公司		CHK'D	DONG. PANG	2012-9-25	
DONG GUAN XI BANG ELECTRONICS CO., LTD.		APPD.	ZENQ. CHEN	2012-9-25	

A	2012-9-25	初版	ZENQ. CHEN
ISSUE	DATE	DESCRIPTIONS OF REVISION	APPD.

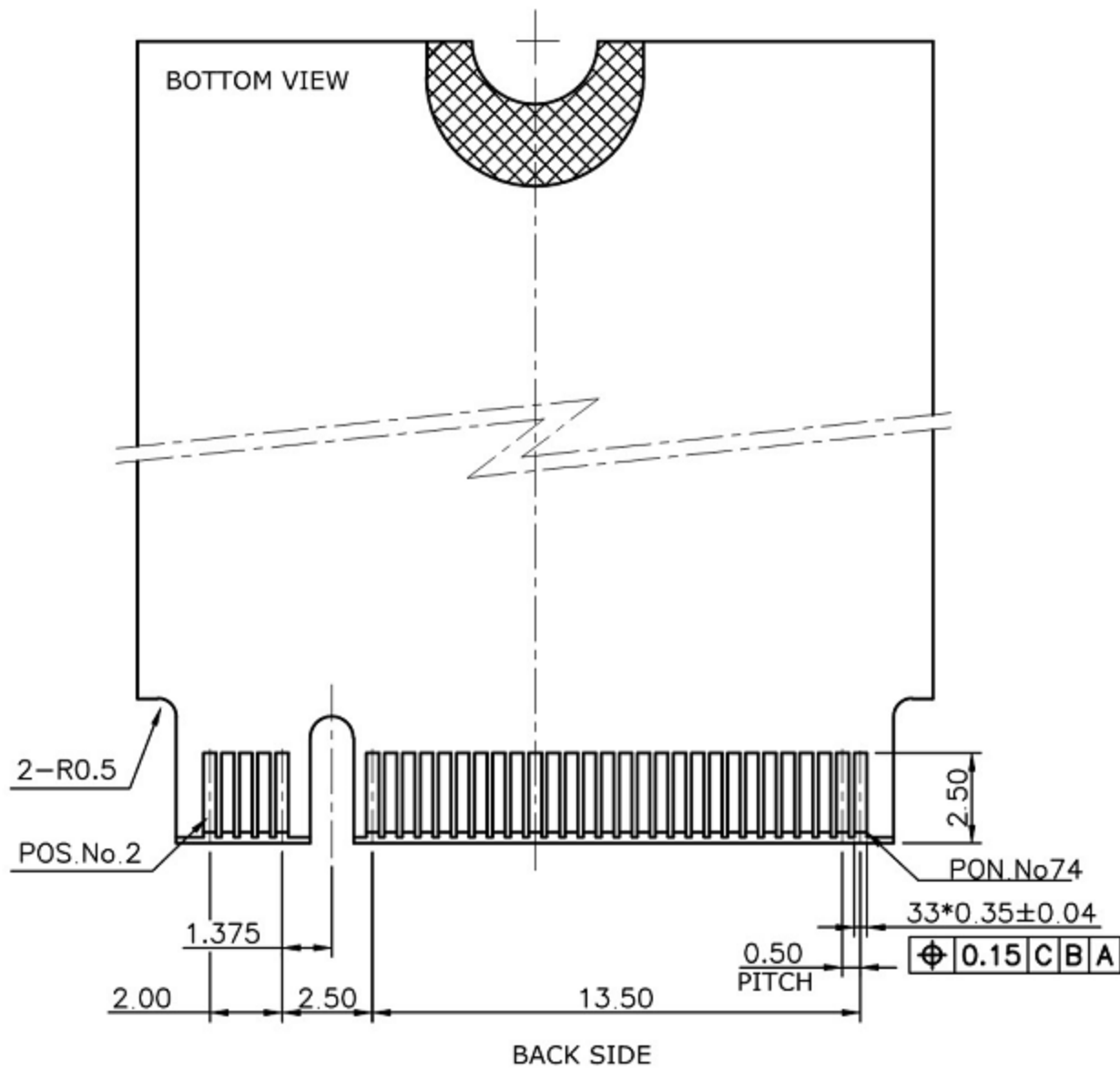


CAD FILE:

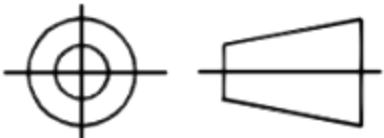
ROHS



REV.	DESCRIPTION	DRAWN	DATE
1	INITIAL RELEASE	FROS	2019/01/09
1.1	Corrected	FROS	2019/09/11

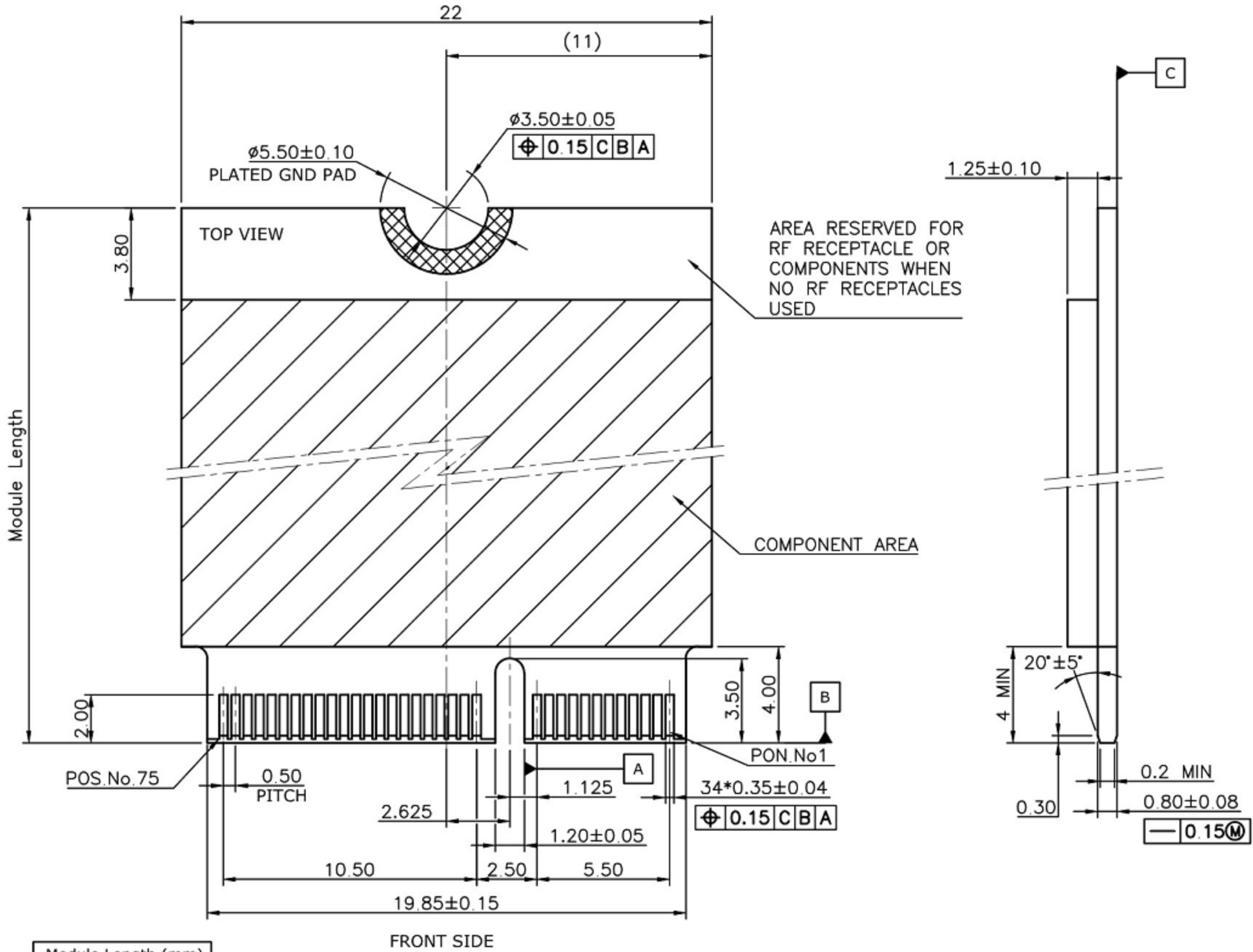


8					TOLERANCE				
7					UNLESS SPECIFIED				
6					WITHIN 1.5mm : ± 0.1 mm	A	2012-9-25	初 版	ZENQ. CHEN
5					OVER 1.5mm : ± 0.2 mm	ISSUE	DATE	DESCRIPTIONS OF REVISION	APPD.
4	CONTACT	SUS	1	Ag CLAD	TITLE : PCB卡插座			UNIT : mm	DRWG NO.: XB-123A-21X00
3	CASE	PPA/BRASS SRTIP	1	BLACK/Ag PLATED	MODEL: PCB Card Socket			SCALE: 5:1	DWN. JUN. YANG 2012-9-25
2	COVER	STEEL STRIP	1	Ni PLATED	 东莞市溪榜电子有限公司 DONG GUAN XI BANG ELECTRONI CS CO., LTD.			CHK'D	DONG. PANG 2012-9-25
1	KNOB	PPA	1	BLACK				APPD.	ZENQ. CHEN 2012-9-25
NO.	PARTS	MATERIALS	Q'TY	FINISH					



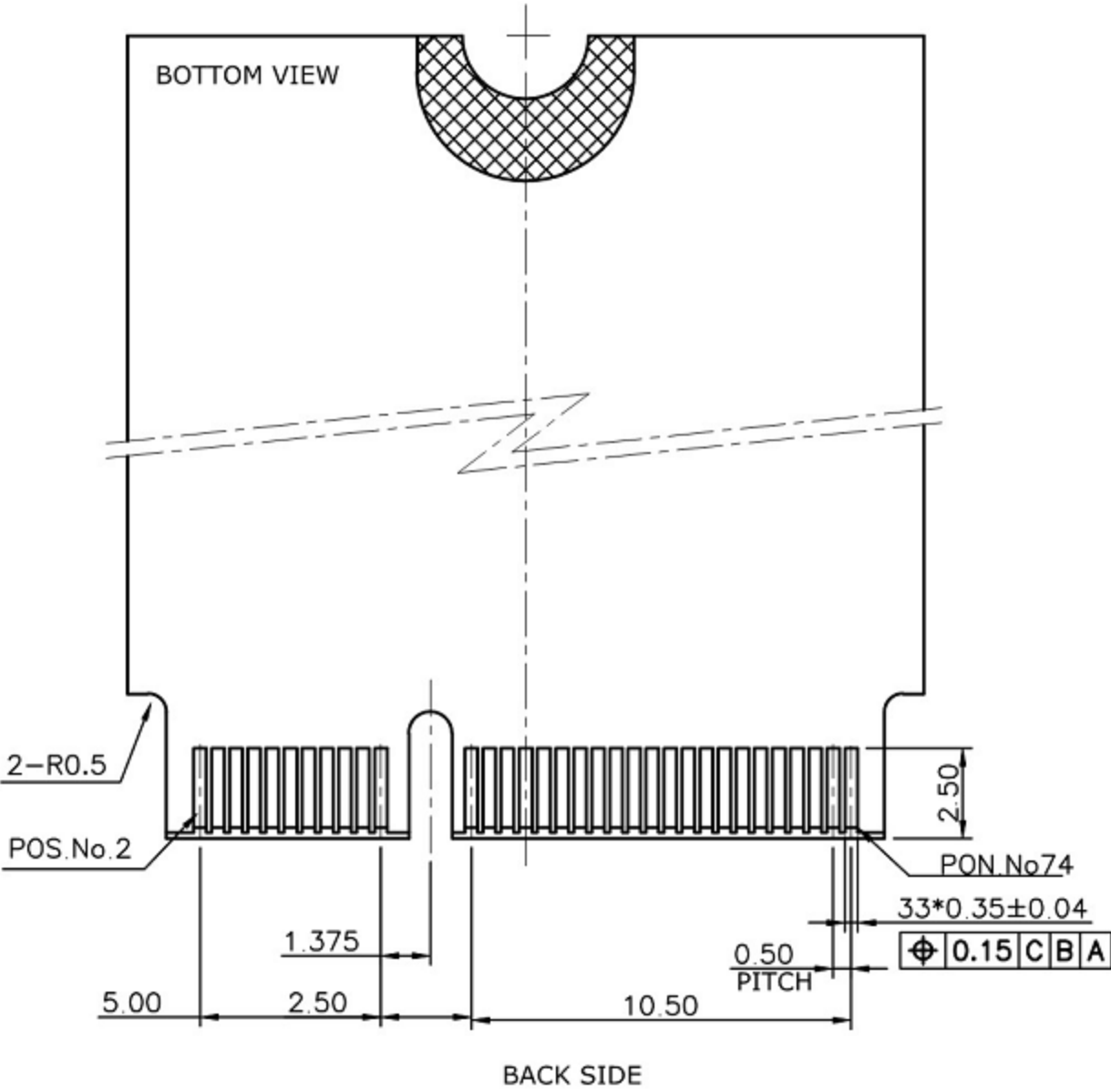
CAD FILE:

ROHS

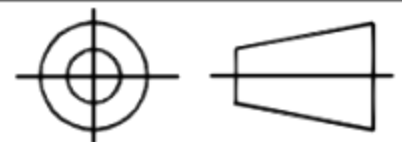


KEY ID "E"
RECOMMENDED MODULE LAYOUT

REV.	DESCRIPTION	DRAWN	DATE
1	INITIAL RELEASE	FROS	2019/01/09
1.1	Corrected	FROS	2019/09/11

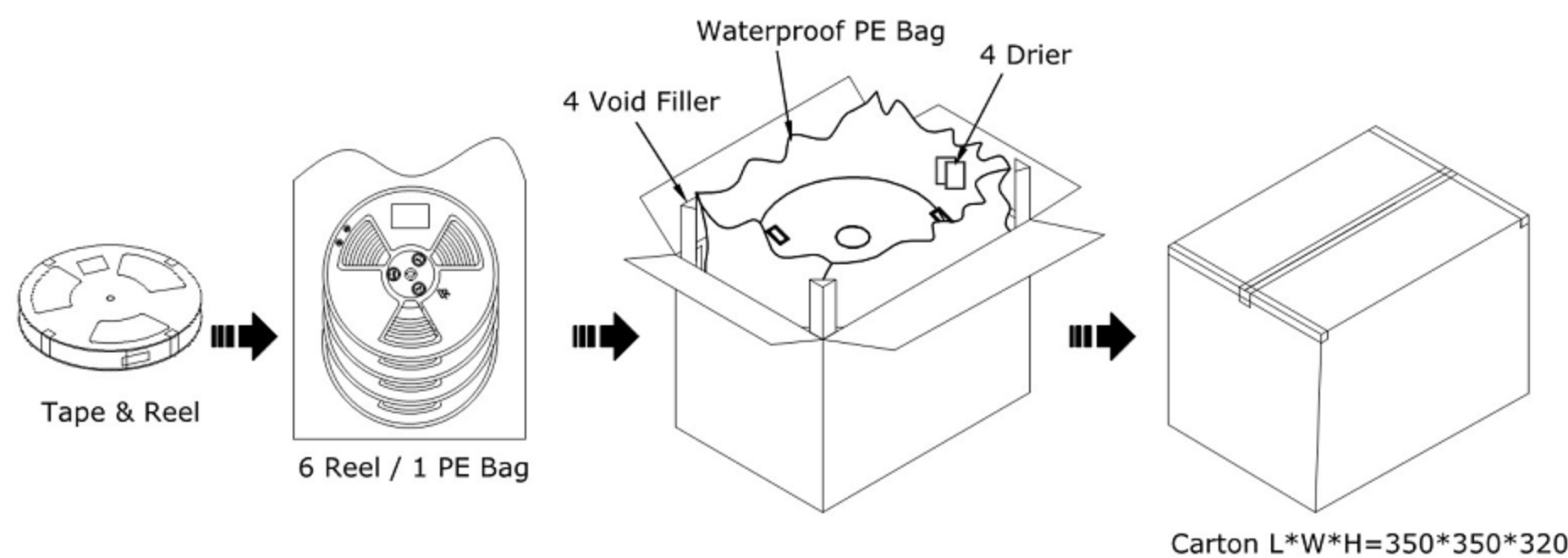
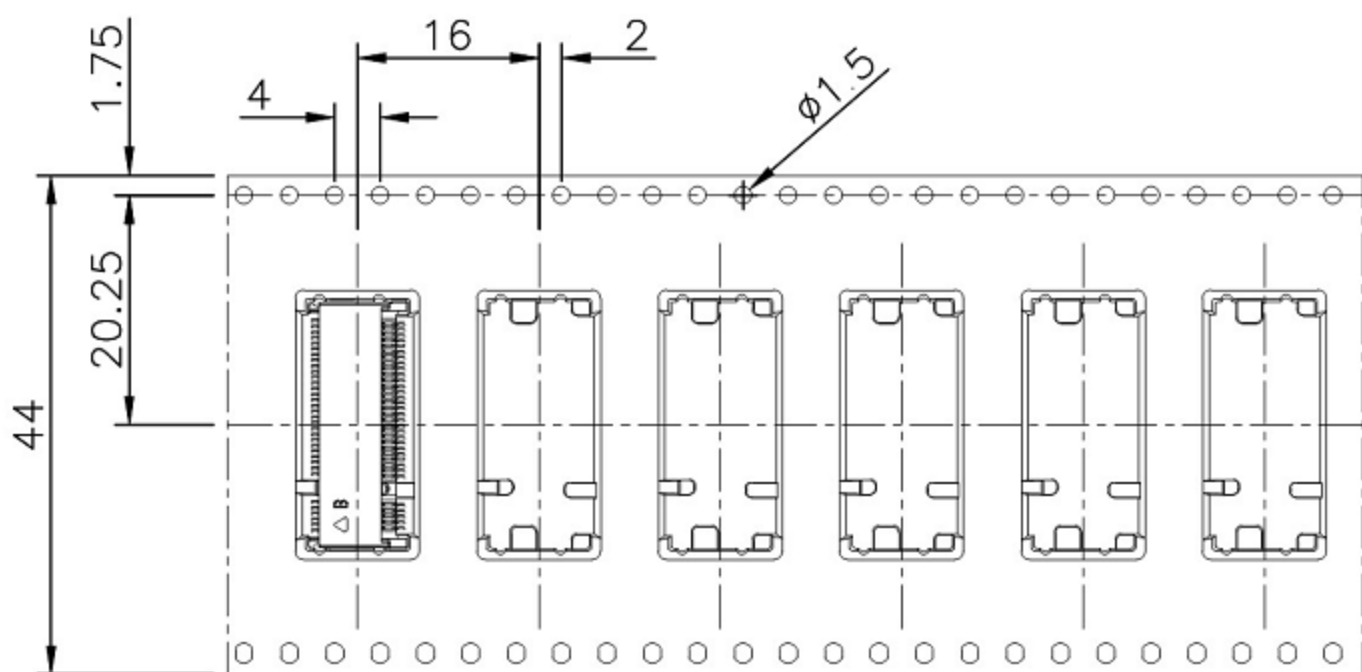
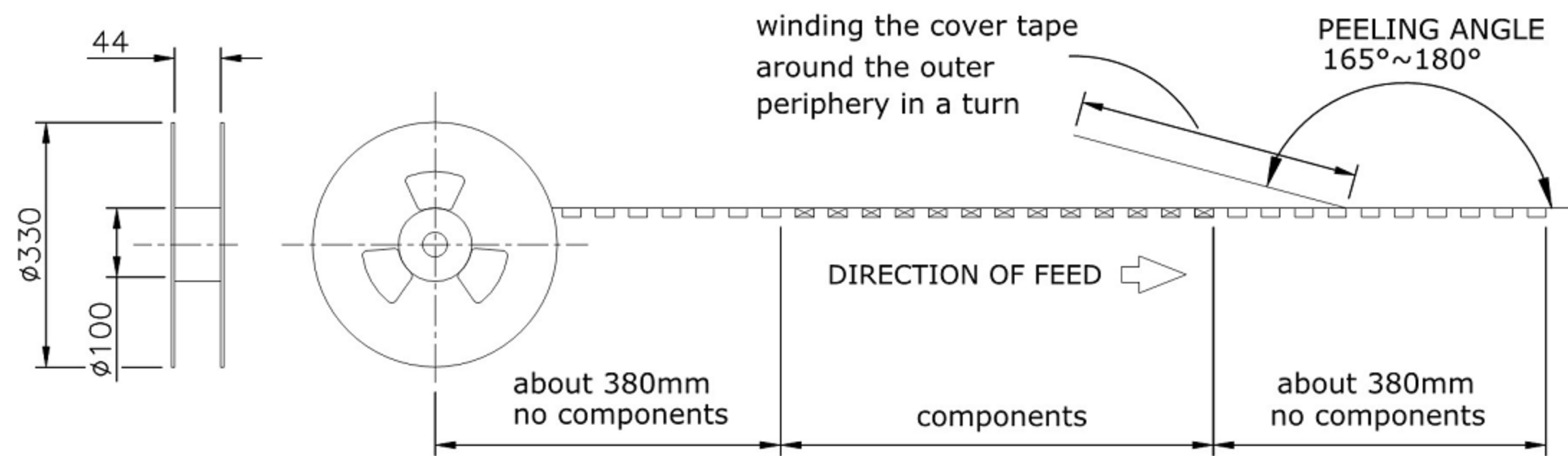


8					TOLERANCE				
7					UNLESS SPECIFIED				
6					WITHIN 1.5mm : ± 0.1 mm	A	2012-9-25	初 版	ZENQ. CHEN
5					OVER 1.5mm : ± 0.2 mm	ISSUE	DATE	DESCRIPTIONS OF REVISION	APPD.
4	CONTACT	SUS	1	Ag CLAD	TITLE : PCB卡插座			UNIT : mm	DRWG NO.: XB-123A-21X00
3	CASE	PPA/BRASS SRTIP	1	BLACK/Ag PLATED	MODEL: PCB Card Socket			SCALE: 5:1	DWN. JUN. YANG 2012-9-25
2	COVER	STEEL STRIP	1	Ni PLATED	 东莞市溪榜电子有限公司 DONG GUAN XI BANG ELECTRONI CS CO., LTD.			CHK'D	DONG. PANG 2012-9-25
1	KNOB	PPA	1	BLACK				APPD.	ZENQ. CHEN 2012-9-25
NO.	PARTS	MATERIALS	Q'TY	FINISH					



CAD FILE:

ROHS



REV.	DESCRIPTION	DRAWN	DATE
1	INITIAL RELEASE	TIM	2018/01/19

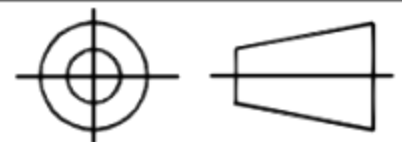
PACKAGING SPECIFICATION:

- MATERIAL
 - Embossed Carrier Tape: PS Black
 - Top Cover Tape: PET
20-80g(Peel Speed 300mm/Minute)
 - Taping Reel: Plastic

2. Packaging:

P/N	Height	Reel	Carton
123A-21X00	2.15	1200	7200
123A-30X00	3.05	900	5400
123A-40X00	4.05	700	4200
123A-58X00	5.80	600	3600

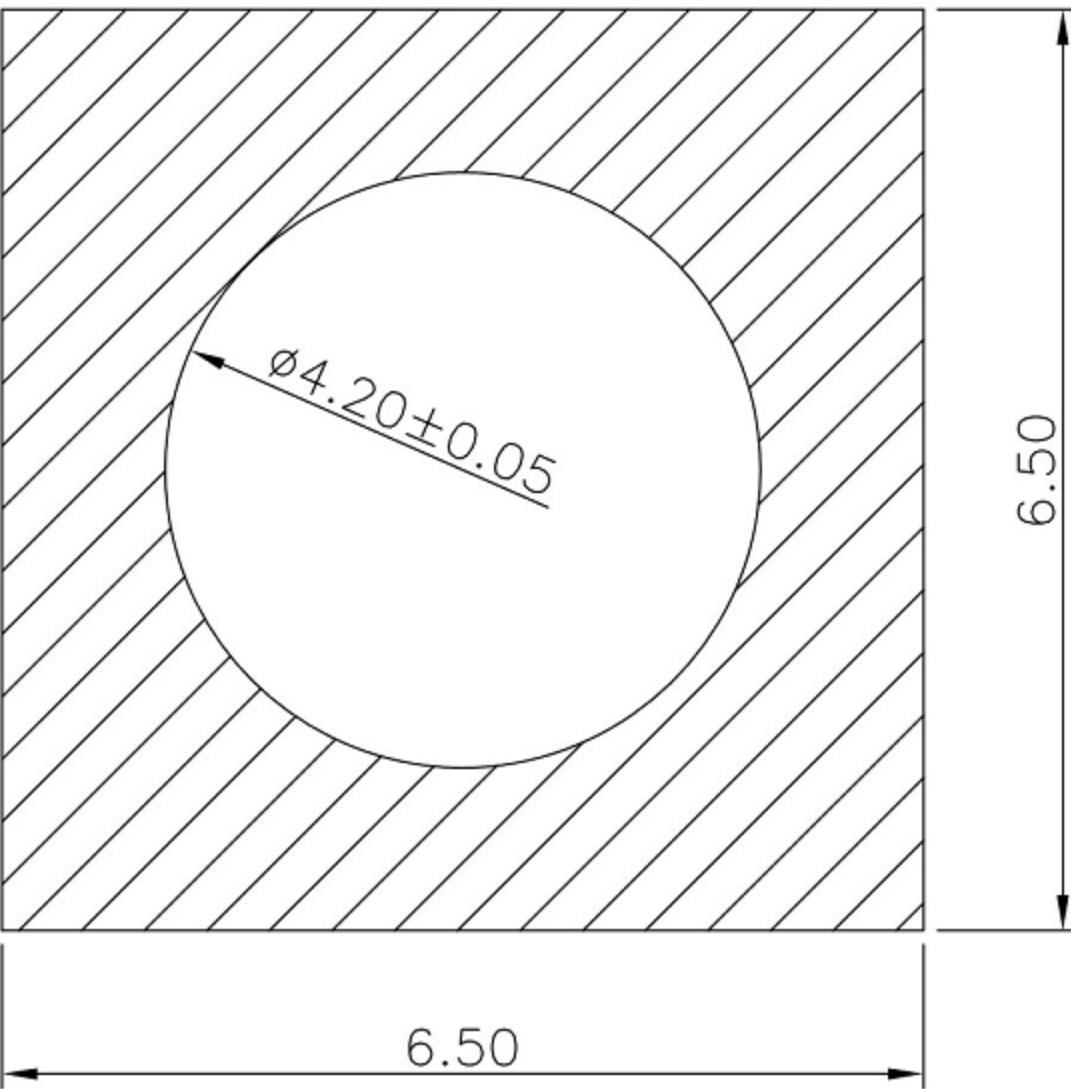
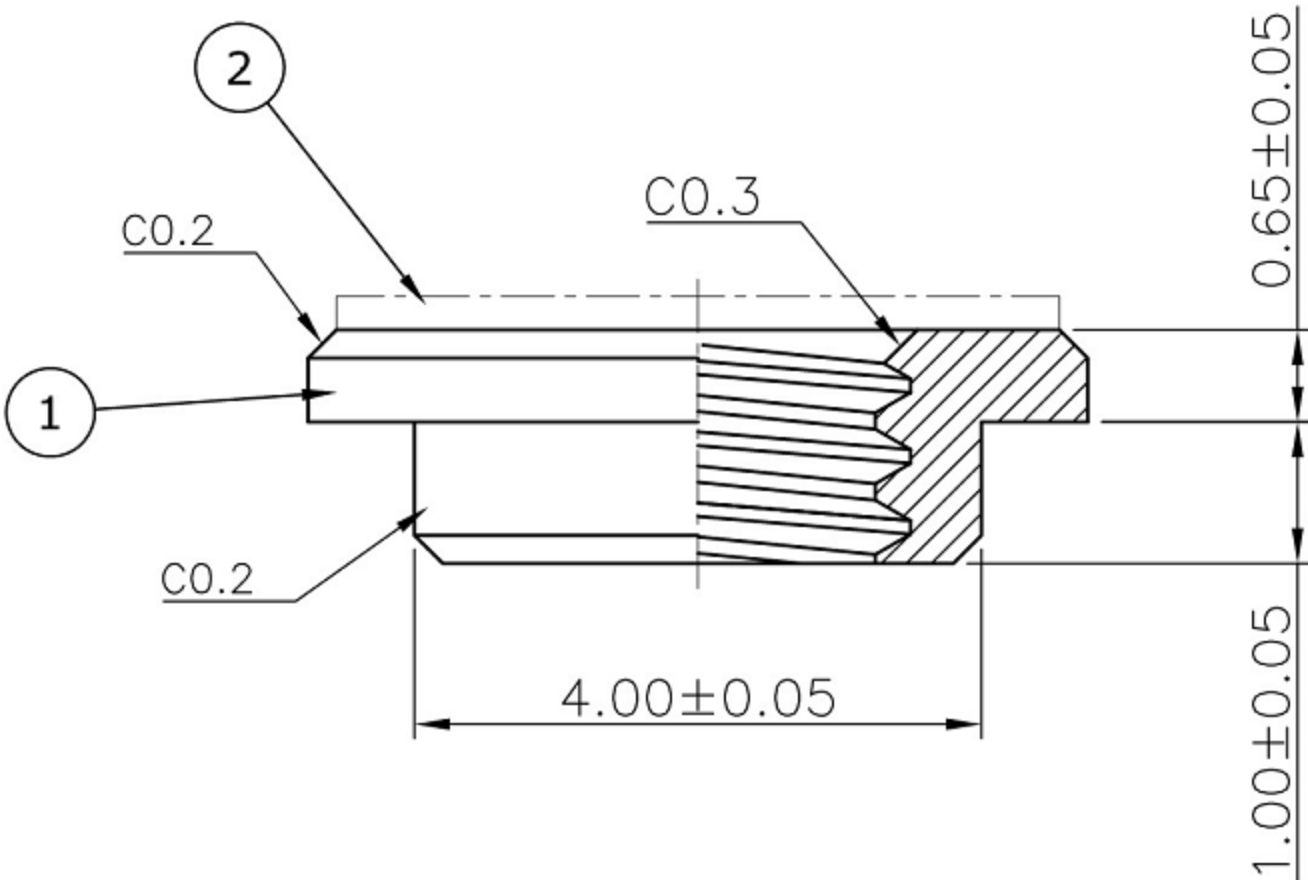
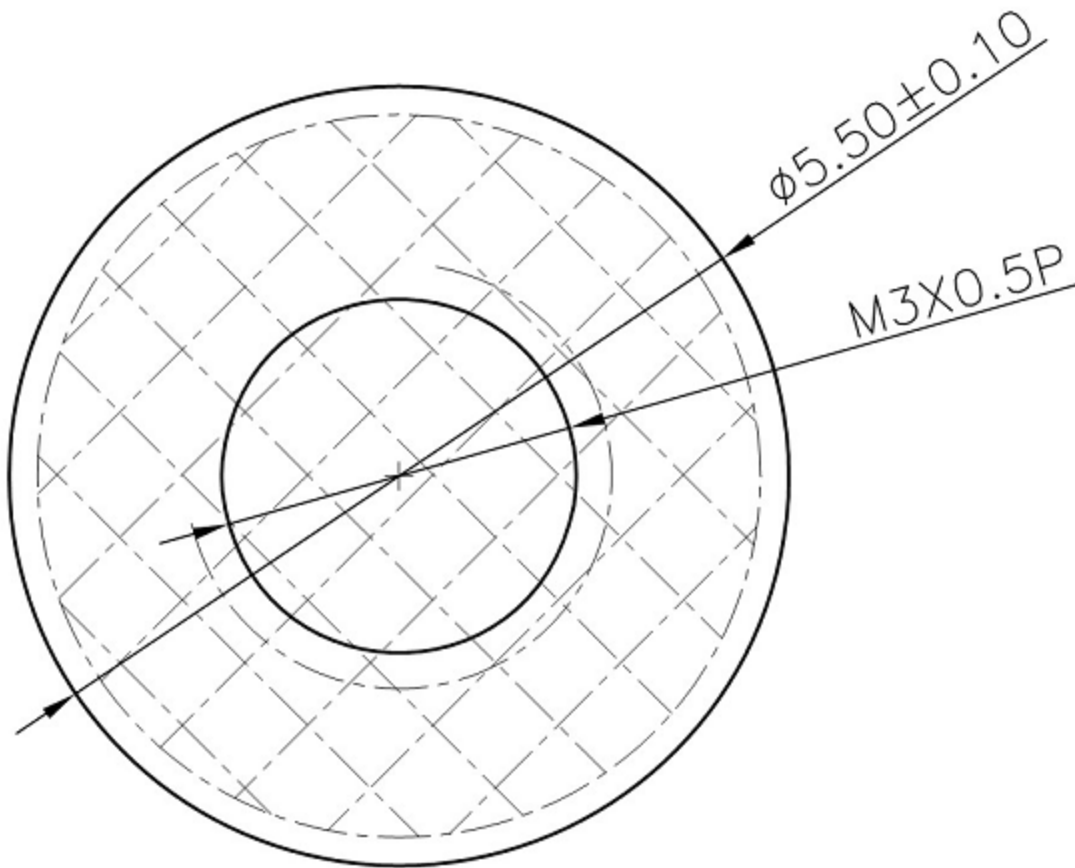
8					TOLERANCE				
7					UNLESS SPECIFIED				
6					WITHIN 1.5mm : ±0.1mm	A	2012-9-25	初 版	ZENQ. CHEN
5					OVER 1.5mm : ±0.2mm	ISSUE	DATE	DESCRIPTIONS OF REVISION	APPD.
4	CONTACT	SUS	1	Ag CLAD	TITLE : PCB卡插座			UNIT : mm	DRWG NO.: XB-123A-21X00
3	CASE	PPA/BRASS SRTIP	1	BLACK/Ag PLATED	MODEL: PCB Card Socket			SCALE: 5:1	DWN. JUN. YANG 2012-9-25
2	COVER	STEEL STRIP	1	Ni PLATED	 东莞市溪榜电子有限公司 DONG GUAN XI BANG ELECTRONI CS CO., LTD.			CHK'D	DONG. PANG 2012-9-25
1	KNOB	PPA	1	BLACK				APPD.	ZENQ. CHEN 2012-9-25
NO.	PARTS	MATERIALS	Q'TY	FINISH					



CAD FILE:

ROHS

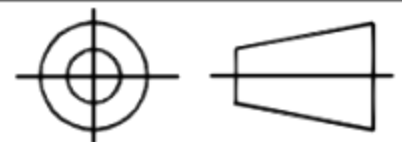
REV.	DESCRIPTION	DRAWN	DATE
1	INITIAL RELEASE	FROS	2015/07/03



RECOMMEND LAYOUT
GENERAL TOLERANCE: ± 0.1

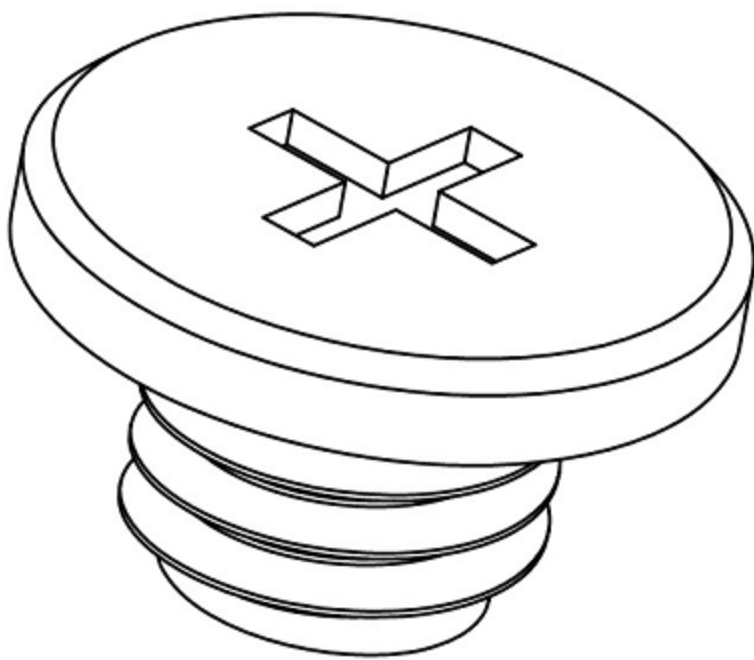
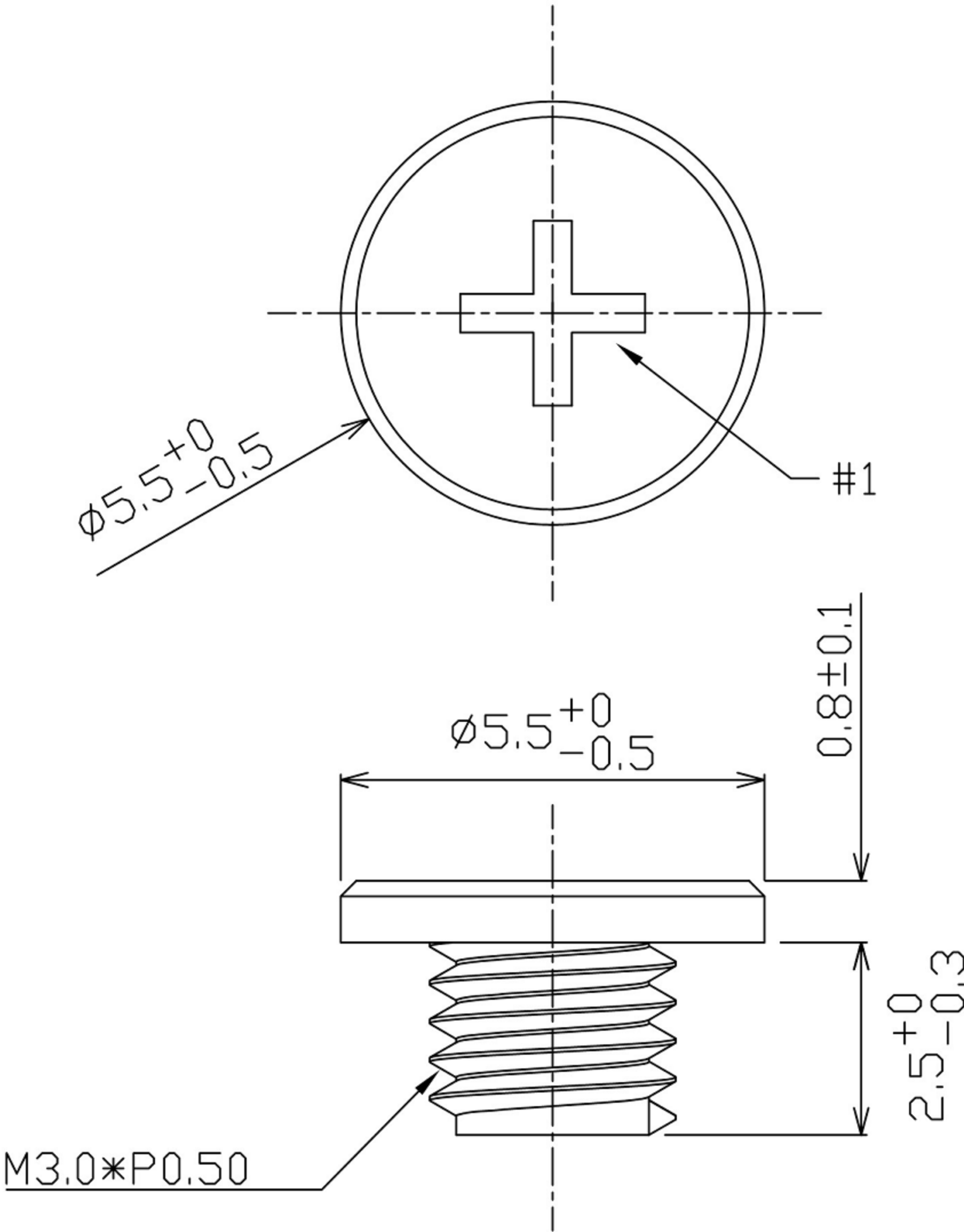
2	MYLAY	
1	NUT	Copper Allory, Sn plated
NO.	PART NAME	DESCRIPTION

8					TOLERANCE				
7					UNLESS SPECIFIED				
6					WITHIN 1.5mm : ± 0.1 mm	A	2012-9-25	初 版	ZENQ. CHEN
5					OVER 1.5mm : ± 0.2 mm	ISSUE	DATE	DESCRIPTIONS OF REVISION	APPD.
4	CONTACT	SUS	1	Ag CLAD	TITLE : PCB卡插座			UNIT : mm	DRWG NO.: XB-123A-21X00
3	CASE	PPA/BRASS SRTIP	1	BLACK/Ag PLATED	MODEL: PCB Card Socket			SCALE: 5:1	DWN. JUN. YANG 2012-9-25
2	COVER	STEEL STRIP	1	Ni PLATED	 东莞市溪榜电子有限公司 DONG GUAN XI BANG ELECTRONI CS CO., LTD.			CHK'D	DONG. PANG 2012-9-25
1	KNOB	PPA	1	BLACK				APPD.	ZENQ. CHEN 2012-9-25
NO.	PARTS	MATERIALS	Q'TY	FINISH					



CAD FILE:

ROHS



Note:
1.Material: Low-carbon steel
2.Plating: Nickel

8					TOLERANCE UNLESS SPECIFIED					
7										
6					WITHIN 1.5mm : $\pm 0.1\text{mm}$ OVER 1.5mm : $\pm 0.2\text{mm}$	A	2012-9-25	初 版		ZENQ. CHEN
5						ISSUE	DATE	DESCRIPTIONS OF REVISION		APPD.
4	CONTACT	SUS	1	Ag CLAD	TITLE : PCB卡插座			UNIT : mm	DRWG NO.: XB-123A-21X00	
3	CASE	PPA/BRASS SRTIP	1	BLACK/Ag PLATED	MODEL: PCB Card Socket			SCALE: 5:1	DWN.	JUN. YANG
2	COVER	STEEL STRIP	1	Ni PLATED	 东莞市溪榜电子有限公司 DONG GUAN XI BANG ELECTRONI CS CO., LTD.				CHK'D	DONG. PANG
1	KNOB	PPA	1	BLACK					APPD.	ZENQ. CHEN
NO.	PARTS	MATERIALS	Q'TY	FINISH						